

Atomic scale characterization of deformation-induced interfacial mixing in a Cu/V nanocomposite wire

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The microstructure of a Cu/V nanocomposite wire processed by cold drawing was investigated by high-resolution transmission electron microscopy and atom probe tomography. The experimental data clearly reveal some deformation-induced interfacial mixing where the vanadium filaments are nanoscaled. The mixed layer is a 2 nm wide vanadium gradient in the face-centered cubic (fcc) Cu phase. This mechanical mixing leads to the local fragmentation and dissolution of the filaments and to the formation of vanadium supersaturated solid solutions in fcc Cu.

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Since the middle of the twentieth century, it has been well established that heavy drawing of two-phase alloys may give rise to some very-high-strength materials. This is the typical case of cold-drawn pearlitic steels that exhibit a mechanical strength higher than 3 GPa and that are widely used as tyre cords. Such unusual properties are attributed to the nanoscaled structure that develops during the drawing process: cementite lamellae are aligned and elongated along the wire axis and after a true strain of about three, the mean interlamellar spacing is typically less than 30 nm [1]. This concept was later extended to copper wires alloyed with Nb [2–5], Ta [6], Fe [7], Cr [8] and Ag [9,10] using various technical strategies like accumulated cold drawing [6], powder metallurgy [7] and processing of cast alloys [2,4,8,10]. All these binary systems are characterized by a very low solubility of the alloying element in the face-centered cubic (fcc) copper phase at room temperature and, during heavy drawing, the two-phase mixture is transformed into a nanoscaled filamentary structure. Such fibrous nanocomposite materials usually exhibit an excellent combination of high strength and good electrical conductivity that is attractive for many applications.

However, it is now well established that during severe plastic deformation, some unique features may occur at the nanoscale, such as deformation-induced phase transformation [11], interdiffusion [12,13] or even amorphization [14], and heavily drawn two-phase materials may also be affected. For instance, in cold-drawn pearlitic steels, it has been demonstrated by various experimental techniques that cementite lamellae may completely decompose [15,16]. In severely drawn Cu–Nb [5] and Cu–Ag [9], supersaturated solid solutions well above the equilibrium solubility limits were observed as a result of deformation-induced intermixing. In the specific case of Cu–Nb this feature was related to the partial solid state amorphization pointed out by high-resolution transmission electron microscopy (HRTEM) [5,17].

The physical mechanisms of such deformation-induced intermixing have been extensively investigated for ball-milled powders [18,19]. However, the situation is very different for severely drawn wires, because the total accumulated strain and the strain rate are much lower and the material flow is continuous (which gives rise to the fibrous nanostructure). The atom probe tomography (APT) technique [20,21] is probably the most appropriate tool to characterize the nanostructure of filamentary composite and to map out diffusion gradients. This was done a few years ago on Cu–Ag [9] and Cu–Nb [5] wires and the experimental data clearly show that intermixing occurs only where the filament thickness is reduced down to only

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a few nanometers. However, these experiments raised two major limitations:

- (1) The field of view of the atom probe used at that time was quite limited (typically $10 \times 10 \text{ nm}^2$ in the cross-section of the wire and 100 nm along the wire axis). This is much smaller than the average length scale of the heterogeneity of the microstructure in such nanocomposite materials, thus it was extremely difficult to get a representative overview of the nanostructure.
- (2) The evaporation field of Cu (30 V nm^{-1}) is different from that of Nb (37 V nm^{-1}) and Ag (24 V nm^{-1}) [21], which could give rise to some local magnification effects and artefact in reconstructed volumes [22].

In the present study, a Cu–V nanocomposite wire was prepared by heavy drawing and the resulting nanostructure was characterized by both scanning transmission electron microscopy (STEM) and APT using a wide-angle atom probe. The main advantage of this system is that Cu and V exhibit the same evaporation field (30 V nm^{-1}) [21], thus it is thought to be ideal for the investigation of the physical mechanisms leading to the non-equilibrium intermixing occurring at the nanoscale. The Cu–V system exhibits a large positive heat of mixing ($\Delta H_{\text{mix}} = 5 \text{ kJ mol}^{-1}$) and is among the so-called immiscible systems [23]. The solubility of V in fcc Cu is indeed extremely limited with a maximum of 0.8 at.% at 1393 K and less than 0.1 at.% near room temperature [24]. On the other side of the phase diagram, the solubility of Cu in bcc V is significantly higher, up to 8 at.% at 1803 K and about 5 at.% near room temperature [24]. It has been shown however that non-equilibrium supersaturated solid solutions can be achieved in this system by mechanical alloying [25–28], melt-spinning [29] or irradiation [30].

The Cu–V alloy was prepared by arc-melting with consumable electrode from high-purity electron-beam melted copper (99.99%) and vanadium (99.9%) with a molar fraction of 80% copper. The initial billet with a diameter of 100 mm was extruded down to 30 mm in diameter and then cold-drawn down to 0.3 mm (cumulated true strain $\gamma = 9.2$). The deformation has been performed without any intermediate heat treatment that could lead to recrystallization of V filaments. The microstructure was characterized by STEM and APT. TEM samples were prepared both in the longitudinal direction and in the cross-section of the wire but only data related to these later specimens are reported here. Since the wire diameter was very small, it was first nickel-coated, then sliced, mechanically ground down to 45 μm and finally specimens were ion milled at 3 keV using a GATAN PIPS 691. Observations were performed using a probe corrected JEOL ARM200F microscope operating at 200 kV in the STEM mode. Image acquisition was performed on JEOL bright-field (BF) and high-angle annular dark field (HAADF) detectors.

APT samples were prepared by standard electropolishing methods (20% H_3PO_4 and 5% H_2SO_4 in methanol (vol.%) at 6 V). Analyses were performed using a CAM-ECAL laser-assisted wide-angle tomographic atom probe (LAWATAP) and samples were field-evaporated at a temperature of 50 K in UHV conditions with femtosec-

ond laser pulses (pulse duration $3.5 \times 10^{-10} \text{ s}$, wavelength 515 nm, spot size 0.1 mm, energy of $2 \times 10^{-7} \text{ J}$, pulse repetition rate 100 kHz). Some samples were also evaporated with electric pulses (data not shown here), to check that some possible local heating due to the laser does not affect composition measurements or three-dimensional (3-D) reconstructions. Thanks to the laser, samples were evaporated with a lower field and larger volumes could be analyzed quantitatively without specimen failure. Data processing was performed using the GPM 3D Data software®.

The combination of BF and HAADF STEM images displayed in Figure 1 shows the cross-sectional view of the microstructure of the Cu–V nanocomposite wire. Vanadium filaments appear in dark on the HAADF image (Fig. 1b) because the atomic number of Cu is larger. These filaments are not homogeneously distributed within the Cu matrix, which is expected for such a composite drawn from a cast ingot [3]. They are strongly curled and this results from the non-axisymmetric elongation of the vanadium bcc filaments that are embedded in the fcc copper phase [3]. This so-called “Van Gogh sky structure” is a well-known consequence of the strong single component $\langle 110 \rangle$ fiber texture that develops during drawing in the body-centered cubic (bcc) vanadium phase [31]. This texture and also the typical $\langle 111 \rangle$ texture of copper were both confirmed by TEM observations of longitudinal specimens (data not shown here). The thickness of vanadium filaments is in a range of few nanometers to 30 nm. The very high ratio of thickness to width of filaments should be mentioned. Grain boundaries within the copper matrix are also clearly exhibited on the BF image (Fig. 1a) thanks to some diffraction contrasts. Due to the plastic flow during drawing, these grains are elongated along the wire axis, and as shown on this image, their cross-sectional dimension is in a range of 50–200 nm. Mainly the grain size is defined by the spacing between V filaments.

High-resolution STEM was carried out to image the nanostructure of filaments at the atomic scale. The bright-field image (Fig. 2a) clearly exhibits atomic columns of the fcc Cu phase oriented in the $\langle 111 \rangle$ zone axis (right part of the image). Lattice fringes corresponding whether to $(111)\text{Cu}$ ($d = 0.208 \text{ nm}$) or $(110)\text{V}$ ($d = 0.214 \text{ nm}$) are also exhibited. Contrary to previous observations on Cu/Nb nanocomposite wires [5,17], amorphous regions were never observed in the present

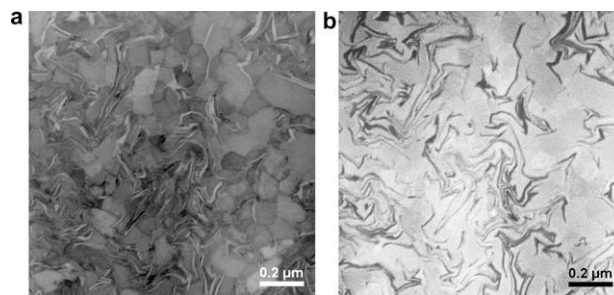


Figure 1. STEM cross-sectional view of the Cu/V nanocomposite wire drawn to a true strain of 9.2: (a) BF image where GBs are exhibited by the diffraction contrast, (b) HAADF image where V filaments are darkly imaged.

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